

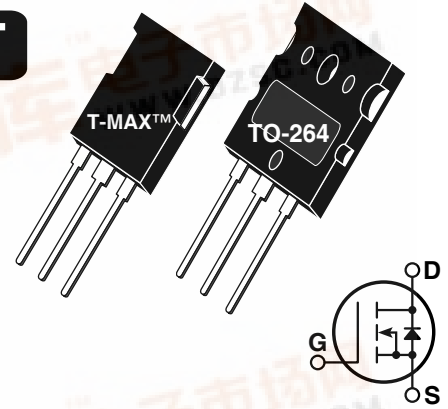


**APT34N80B2C3**  
**APT34N80LC3**  
**800V 34A 0.145Ω**

**Super Junction MOSFET**



- Ultra low  $R_{DS(ON)}$
- Low Miller Capacitance
- Ultra Low Gate Charge,  $Q_g$
- Avalanche Energy Rated
- Popular T-MAX™ or TO-264 Package



**MAXIMUM RATINGS**

All Ratings:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	APT34N80B2C3_LC3	UNIT
$V_{DSS}$	Drain-Source Voltage	800	Volts
$I_D$	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	34	Amps
$I_{DM}$	Pulsed Drain Current <sup>①</sup>	102	
$V_{GS}$	Gate-Source Voltage Continuous	$\pm 20$	Volts
$V_{GSM}$	Gate-Source Voltage Transient	$\pm 30$	
$P_D$	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	417	Watts
	Linear Derating Factor	3.33	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 150	$^\circ\text{C}$
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	300	
$dv/dt$	Drain-Source Voltage slope ( $V_{DS} = 640\text{V}$ , $I_D = 34\text{A}$ , $T_J = 125^\circ\text{C}$ )	50	V/ns
$I_{AR}$	Repetitive Avalanche Current <sup>⑦</sup>	17	Amps
$E_{AR}$	Repetitive Avalanche Energy <sup>⑦</sup>	0.5	mJ
$E_{AS}$	Single Pulse Avalanche Energy <sup>④</sup>	670	

**STATIC ELECTRICAL CHARACTERISTICS**

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$BV_{DSS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0\text{V}$ , $I_D = 500\mu\text{A}$ )	800			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance <sup>②</sup> ( $V_{GS} = 10\text{V}$ , $I_D = 22\text{A}$ )		0.125	0.145	Ohms
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = 800\text{V}$ , $V_{GS} = 0\text{V}$ )		1.0	50	$\mu\text{A}$
	Zero Gate Voltage Drain Current ( $V_{DS} = 800\text{V}$ , $V_{GS} = 0\text{V}$ , $T_J = 150^\circ\text{C}$ )			500	
$I_{GSS}$	Gate-Source Leakage Current ( $V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$ )			$\pm 200$	nA
$V_{GS(th)}$	Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 2\text{mA}$ )	2.10	3	3.9	Volts

**CAUTION:** These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

**DYNAMIC CHARACTERISTICS**

**APT34N80B2C3 LC3**

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		4510		pF
$C_{oss}$	Output Capacitance			2050		
$C_{rss}$	Reverse Transfer Capacitance			110		
$Q_g$	Total Gate Charge ③	$V_{GS} = 10V$ $V_{DD} = 400V$ $I_D = 34A @ 25^\circ C$		180	355	nC
$Q_{gs}$	Gate-Source Charge			22		
$Q_{gd}$	Gate-Drain ("Miller") Charge			90		
$t_{d(on)}$	Turn-on Delay Time	<b>RESISTIVE SWITCHING</b> $V_{GS} = 10V$ $V_{DD} = 400V$ $I_D = 34A @ 125^\circ C$ $R_G = 2.5\Omega$		25		ns
$t_r$	Rise Time			15		
$t_{d(off)}$	Turn-off Delay Time			70	80	
$t_f$	Fall Time			6	9	
$E_{on}$	Turn-on Switching Energy ⑥	<b>INDUCTIVE SWITCHING @ 25°C</b> $V_{DD} = 533V, V_{GS} = 15V$ $I_D = 34A, R_G = 5\Omega$		675		$\mu J$
$E_{off}$	Turn-off Switching Energy			580		
$E_{on}$	Turn-on Switching Energy ⑥	<b>INDUCTIVE SWITCHING @ 125°C</b> $V_{DD} = 533V, V_{GS} = 15V$ $I_D = 34A, R_G = 5\Omega$		1145		
$E_{off}$	Turn-off Switching Energy			670		

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS**

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$I_S$	Continuous Source Current (Body Diode)			34	Amps
$I_{SM}$	Pulsed Source Current ① (Body Diode)			102	
$V_{SD}$	Diode Forward Voltage ② ( $V_{GS} = 0V, I_S = -34A$ )		1	1.2	Volts
$t_{rr}$	Reverse Recovery Time ( $I_S = -34A, di_S/dt = 100A/\mu s, V_R = 400V$ )		855		ns
$Q_{rr}$	Reverse Recovery Charge ( $I_S = -34A, di_S/dt = 100A/\mu s, V_R = 400V$ )		30		$\mu C$
$dv/dt$	Peak Diode Recovery $dv/dt$ ⑤			6	V/ns

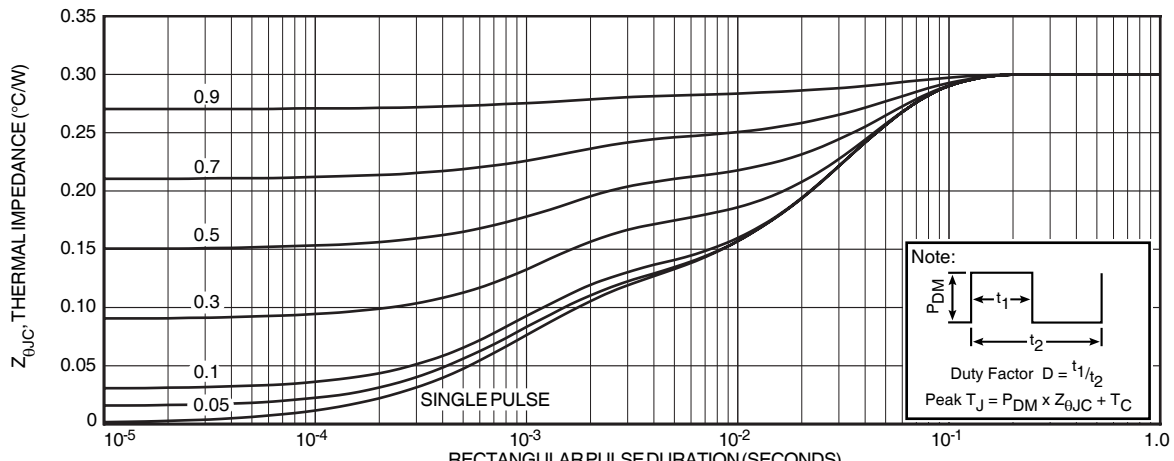
**THERMAL CHARACTERISTICS**

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			.30	$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient			40	

- ① Repetitive Rating: Pulse width limited by maximum junction temperature
- ② Pulse Test: Pulse width < 380  $\mu s$ , Duty Cycle < 2%
- ③ See MIL-STD-750 Method 3471

- ④ Starting  $T_j = +25^\circ C, L = 115.92mH, R_G = 25\Omega, \text{Peak } I_L = 3.4A$
- ⑤  $I_S = -34A, di/dt = 100A/\mu s, V_R = 480V, T_j = 125^\circ C$
- ⑥  $E_{on}$  includes diode reverse recovery. See figures 18, 20.
- ⑦ Repetitive avalanche causes additional power losses that can be calculated as  $P_{AV} = E_{AR} \cdot f$

APT Reserves the right to change, without notice, the specifications and information contained herein.



Typical Performance Curves

APT34N80B2C3\_LC3

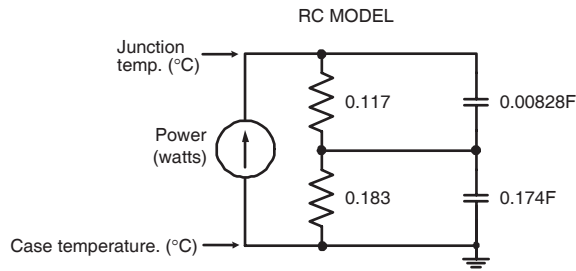


FIGURE 2, TRANSIENT THERMAL IMPEDANCE MODEL

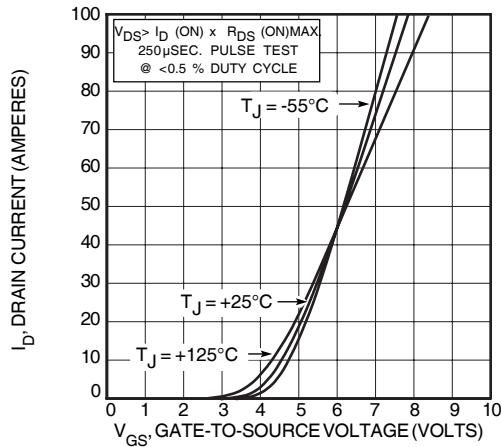


FIGURE 4, TRANSFER CHARACTERISTICS

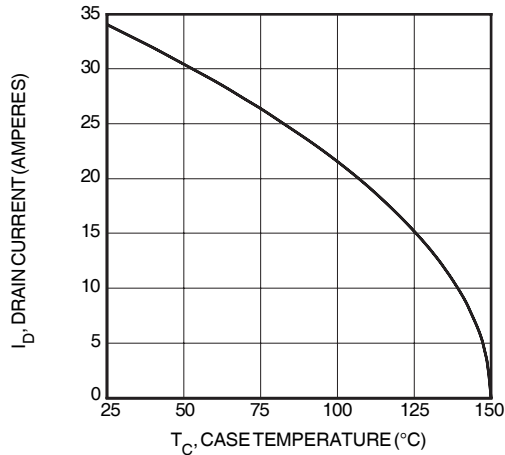


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

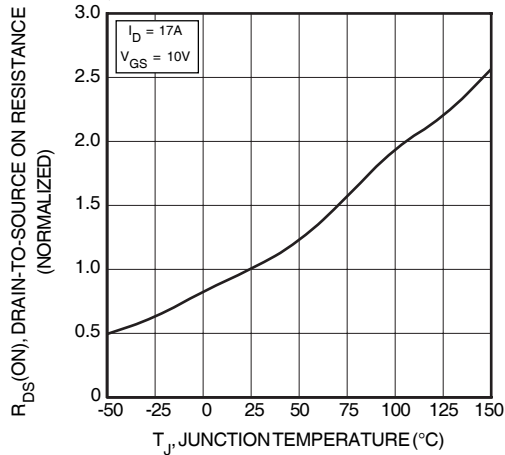


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

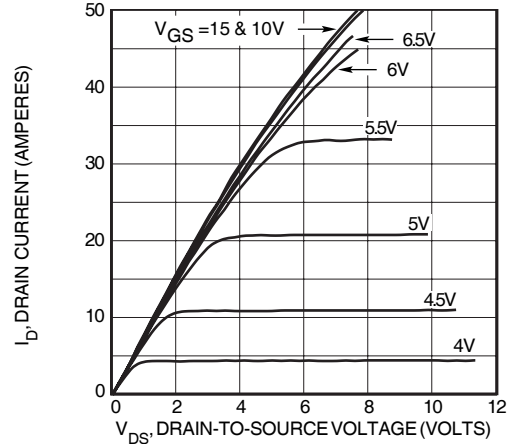


FIGURE 3, LOW VOLTAGE OUTPUT CHARACTERISTICS

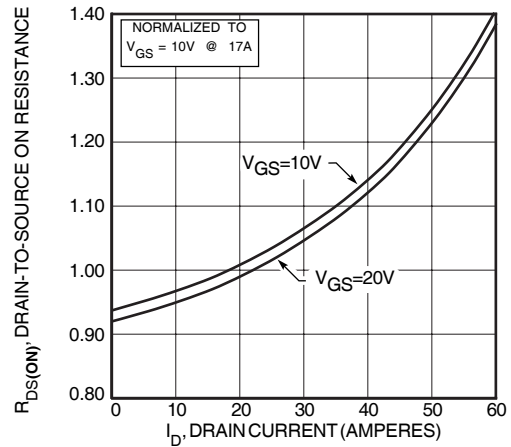


FIGURE 5,  $R_{DS(ON)}$  vs DRAIN CURRENT

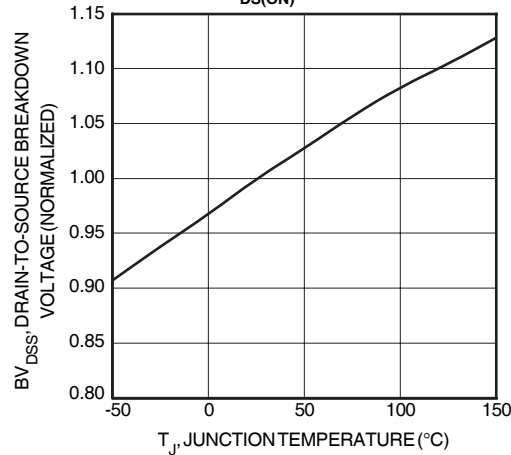


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

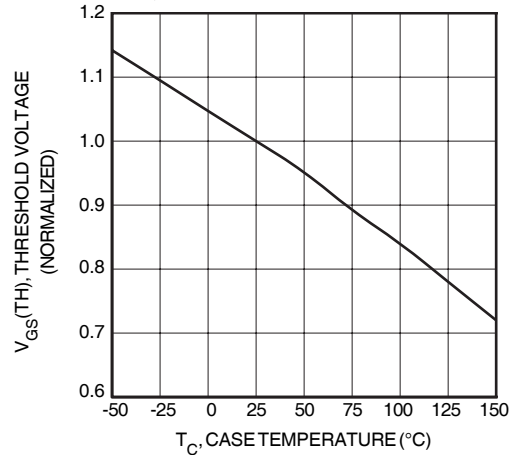


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

Typical Performance Curves

APT34N80B2C3\_LC3

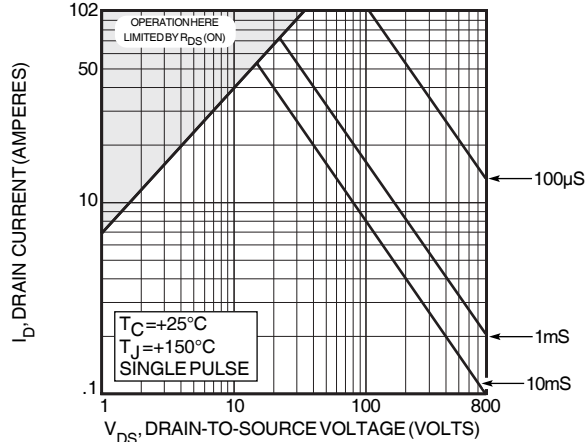


FIGURE 10, MAXIMUM SAFE OPERATING AREA

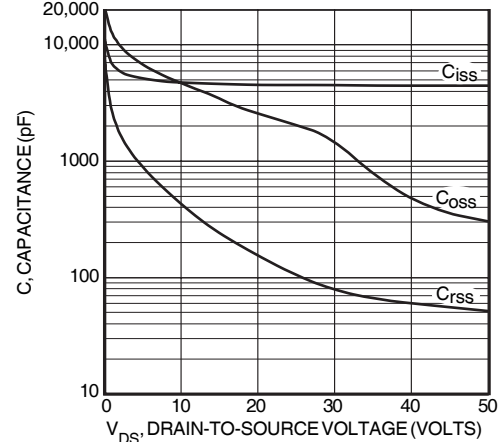


FIGURE 11, CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

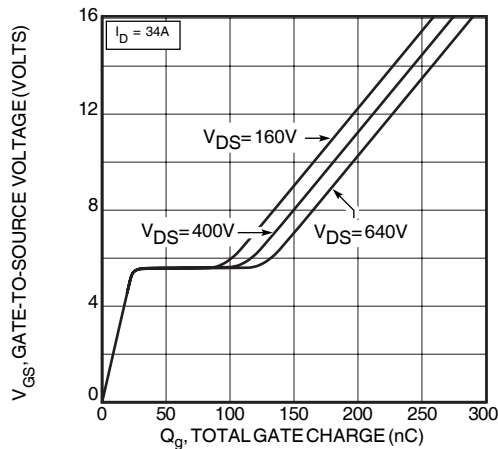


FIGURE 12, GATE CHARGES vs GATE-TO-SOURCE VOLTAGE

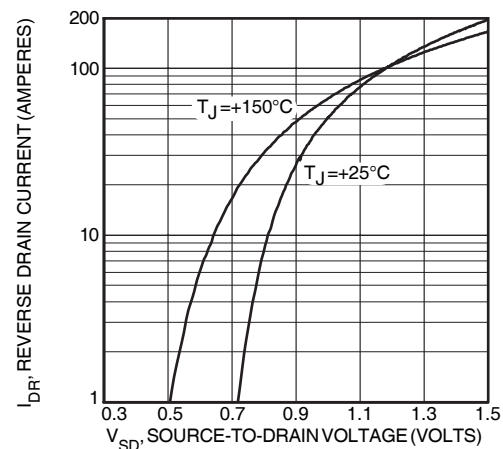


FIGURE 13, SOURCE-DRAIN DIODE FORWARD VOLTAGE

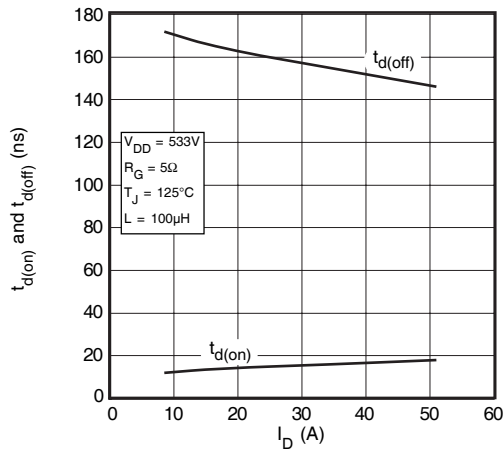


FIGURE 14, DELAY TIMES vs CURRENT

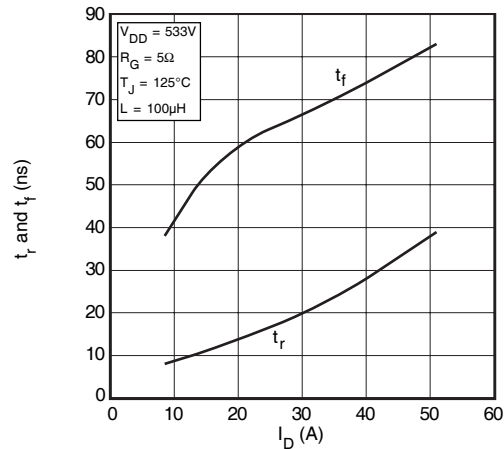


FIGURE 15, RISE AND FALL TIMES vs CURRENT

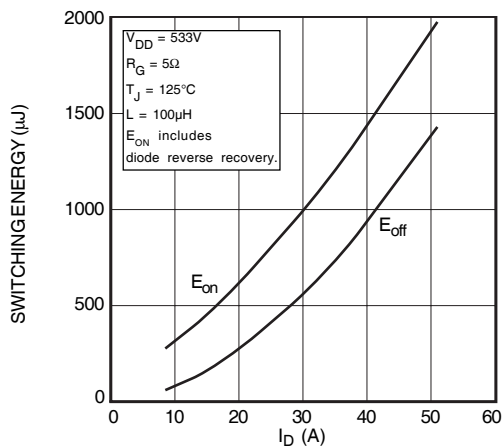


FIGURE 16, SWITCHING ENERGY vs CURRENT

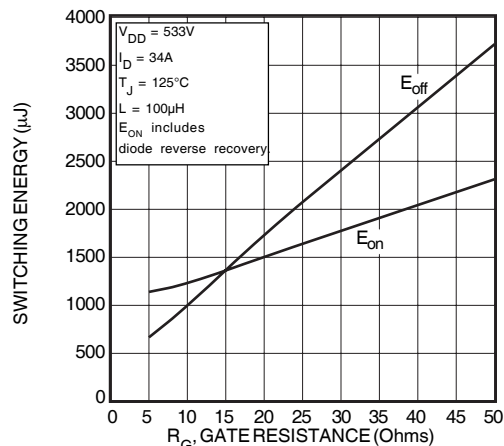


FIGURE 17, SWITCHING ENERGY vs. GATE RESISTANCE

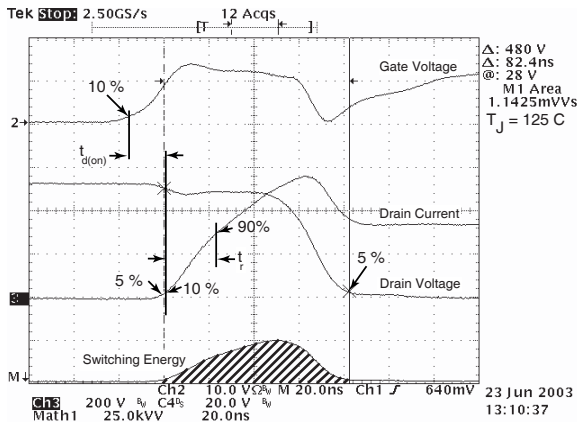


Figure 18, Turn-on Switching Waveforms and Definitions

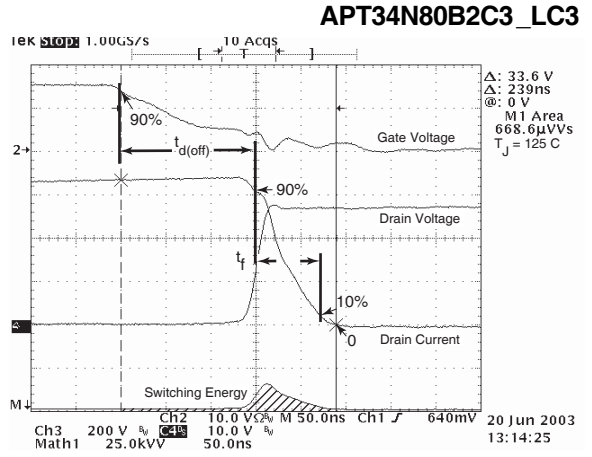


Figure 19, Turn-off Switching Waveforms and Definitions

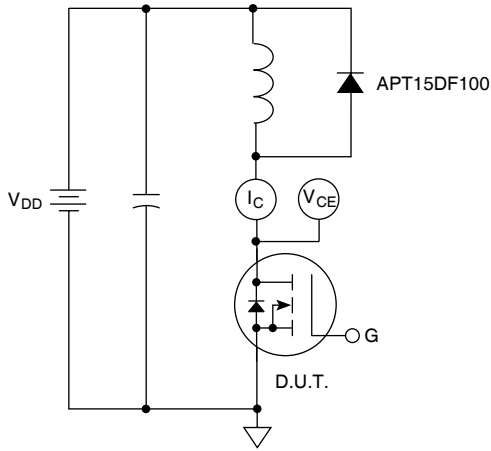
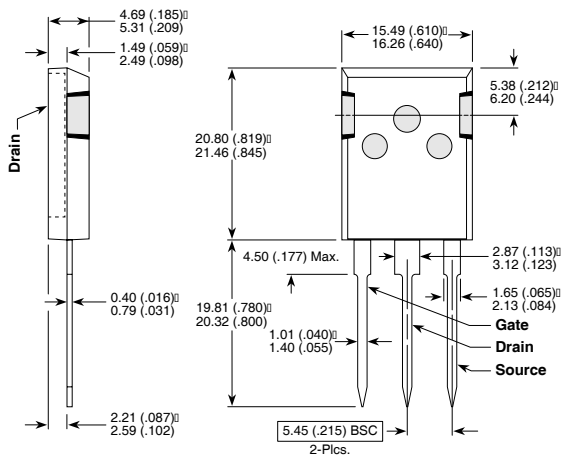


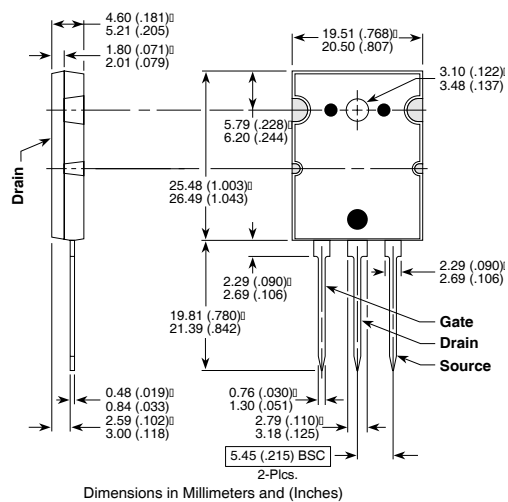
Figure 20, Inductive Switching Test Circuit

T-MAX™ (B2) Package Outline



These dimensions are equal to the TO-247 without the mounting hole.  
Dimensions in Millimeters and (Inches)

TO-264 (L) Package Outline



Dimensions in Millimeters and (Inches)